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March 2015



FDD3670

100V N-Channel PowerTrench[®] MOSFET

General Description

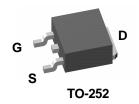
This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers.

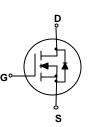
These MOSFETs f eature faster switching and lower gate charge than other MOSFETs with comparable $R_{DS(ON)}$ specifications.

The result is a MOSFET that is easy and safer to drive (even at very high frequencies), and DC/DC power supply designs with higher overall efficiency.

Features

- 34 A, 100 V. $R_{DS(ON)} = 32 \text{ m}\Omega @ V_{GS} = 10 \text{ V}$ $R_{DS(ON)} = 35 \text{ m}\Omega @ V_{GS} = 6 \text{ V}$
- Low gate charge (57 nC typical)
- Fast switching speed
- + High performance trench technology for extremely low $R_{\text{DS}(\text{ON})}$
- High power and current handling capability





Absolute Maximum Ratings T_A=25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V _{DSS}	Drain-Source Voltage		100	V
V _{GSS}	Gate-Source Voltage		±20	V
l _D	Drain Current – Continuous	(Note 1)	34	A
	Drain Current – Pulsed	(Note 3)	100	
PD	Maximum Power Dissipation @ T _C = 25°C (Note 1)		83	W
	@ T _A = 25°C	(Note 1a)	3.8	
	@ T _A = 25°C	(Note 1b)	1.6	
T _J , T _{STG}	Operating and Storage Junction Temperature Range		–55 to +175	°C

Thermal Characteristics

R _{0JC}	Thermal Resistance, Junction-to-Case	(Note 1)	1.8	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1b)	96	°C/W

Package Marking and Ordering Information

FDD3670 FDD3670 13" 16mm 2500 ur	Device Marking	Device	Reel Size	Tape width	Quantity
	FDD3670	FDD3670	13"	16mm	2500 units

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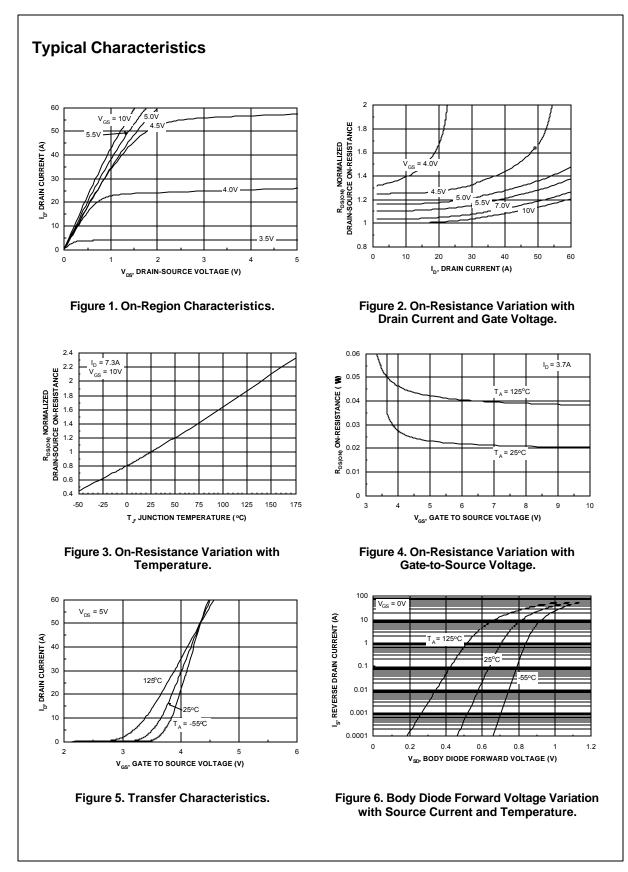
FDD3670

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Drain-So	ource Avalanche Ratings (Note	2)				
W _{DSS}	Single Pulse Drain-Source	$V_{DD} = 50 V, \qquad I_D = 7.3 A$			360	mJ
I _{AR}	Avalanche Energy Maximum Drain-Source Avalanche				7.3	A
AR	Current				1.0	~
Off Char	acteristics					
BV DSS	Drain–Source Breakdown Voltage	V _{GS} = 0 V, Ι _D = 250 μA	100			V
<u>ΔBVdss</u> ΔTj	Breakdown Voltage Temperature Coefficient	I_D = 250 µA, Referenced to 25°C		92		mV/°C
DSS	Zero Gate Voltage Drain Current	$V_{DS} = 80 V, V_{GS} = 0 V$			10	μA
GSSF	Gate–Body Leakage, Forward	$V_{GS} = 20 V, V_{DS} = 0 V$			100	nA
GSSR	Gate–Body Leakage, Reverse	$V_{GS} = -20 V$, $V_{DS} = 0 V$			-100	nA
On Char	acteristics (Note 2)		•	1		
V _{GS(th)}	Gate Threshold Voltage	V _{DS} = V _{GS} , I _D = 250 μA	2	2.5	4	V
<u>ΔVgs(th)</u> ΔTj	Gate Threshold Voltage Temperature Coefficient	I_D = 250 µA, Referenced to 25°C		-7.2		mV/º0
R _{DS(on)}	Static Drain-Source	$V_{GS} = 10 \text{ V}, I_D = 7.3 \text{ A}$		22	32	mΩ
	On–Resistance	$V_{GS} = 10 \text{ V}, \text{ I}_D = 7.3 \text{ A}, \text{ T}_J = 125^{\circ}\text{C}$ $V_{GS} = 6 \text{ V}, \qquad \text{I}_D = 7.0 \text{ A}$		39 24	56 35	
D(on)	On–State Drain Current	$V_{GS} = 10 \text{ V}, V_{DS} = 5 \text{ V}$	25			Α
]FS	Forward Transconductance	$V_{DS} = 5 V$, $I_D = 7.3 A$	15	31		S
Dvnamic	Characteristics			1		1
C _{iss}	Input Capacitance	$V_{DS} = 50 V$, $V_{GS} = 0 V$,	Γ	2490		pF
Coss	Output Capacitance	f = 1.0 MHz		265		pF
Crss	Reverse Transfer Capacitance			80		pF
Switchin	g Characteristics (Note 2)			1		1
t _{d(on)}	Turn–On Delay Time	$V_{DD} = 50 V$, $I_D = 1 A$,	1	16	26	ns
t _r	Turn–On Rise Time	$V_{GS} = 10 \text{ V}, R_{GEN} = 6 \Omega$		10	18	ns
d(off)	Turn–Off Delay Time			56	84	ns
f	Turn–Off Fall Time			25	40	ns
Qg	Total Gate Charge	$V_{\rm DS} = 50 \text{ V}, I_{\rm D} = 7.3 \text{ A},$		57	80	nC
Q _{gs}	Gate–Source Charge	V _{GS} = 10 V		11		nC
Q _{gd}	Gate–Drain Charge			15		nC
Drain_S	ource Diode Characteristics	and Maximum Ratings			1	
ls	Maximum Continuous Drain–Source				2.7	Α
	Drain–Source Diode Forward			0.70		V
V _{SD}	Voltage	$V_{GS} = 0 V$, $I_S = 2.7 A$ (Note 2)		0.72	1.2	v

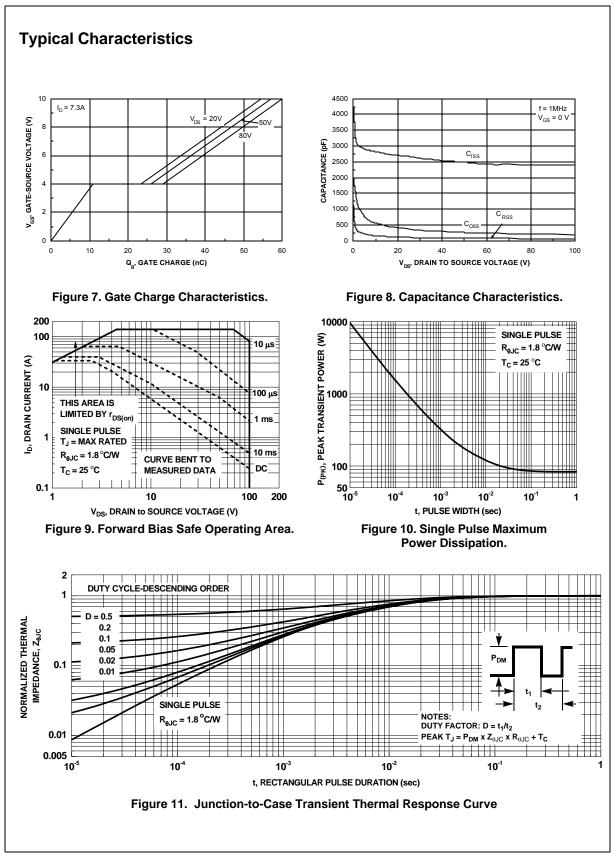
Scale 1 : 1 on letter size paper

2. Pulse Test: Pulse Width < 300 μ s, Duty Cycle < 2.0%

3. Pulse Id refers to Figure.9 Forward Bias Safe Operation Area.



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FDD3670 Rev.1.5



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